

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>		NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>		ASSIGNMENT
<b>CONVEYING PARTY DATA</b>		
<b>Name</b>		<b>Execution Date</b>
Te-Chang TSENG		09/22/2008
Chun-Yi TU		09/22/2008
Hideki Arakawa		09/22/2008
Yamasaki Kyoji		09/22/2008
<b>RECEIVING PARTY DATA</b>		
<b>Name:</b>	Powerchip Semiconductor Corp	
<b>Street Address:</b>	No. 12, Li-Hsin Rd. I, Science-Based Industrial Park	
<b>City:</b>	Hsin-Chu	
<b>State/Country:</b>	TAIWAN	
<b>PROPERTY NUMBERS Total: 1</b>		
<b>Property Type</b>	<b>Number</b>	
Application Number:	12335189	
<b>CORRESPONDENCE DATA</b>		
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<b>ATTORNEY DOCKET NUMBER:</b>	0941/2313PUS1	
<b>NAME OF SUBMITTER:</b>	Joe McKinney Muncy	
<b>Total Attachments: 2</b>		
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OP \$40.00 12335189

**PATENT**

# ASSIGNMENT

WHEREAS, Te-Chang TSENG, Chun-Yi TU, Hideki Arakawa, and Yamasaki Kyoji hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: INTEGRATED CIRCUITS AND DISCHARGE CIRCUITS

Filed: 12/15/2008

Serial No. 12335189

Executed on: September 22, 2008

WHEREAS, Powerchip Semiconductor Corp. of No. 12, Li-Hsin Rd. I, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Te-Chang TSENG  
Te-Chang TSENG

Sep. 22, 2008  
Date

Chun-Yi TU  
Chun-Yi TU

Sep. 22 2008  
Date

ASSIGNMENT

Hideki Arakawa  
Hideki Arakawa

Sep. 22, 2008  
Date

Keiji Yamada  
Yamada Keiji

Sep. 22, 2008  
Date